



HIGH SPEED NPN POWER TRANSISTORS

MJH13090
MJH13091

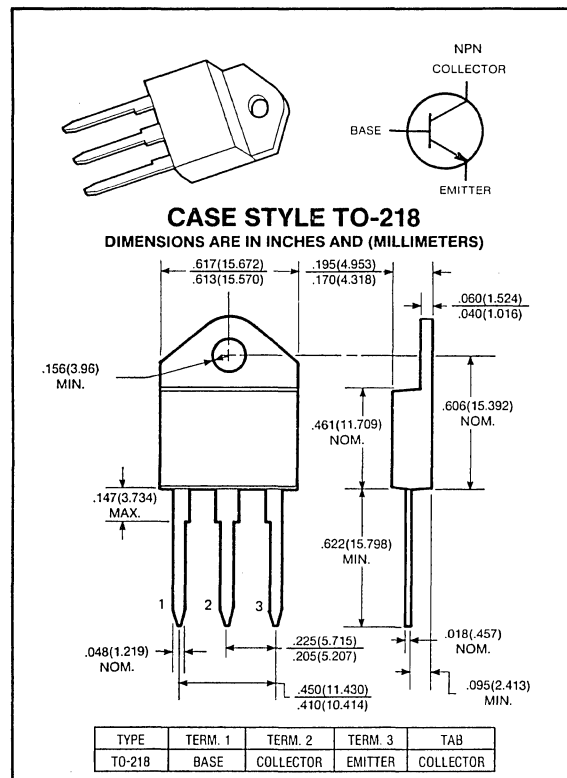
400 & 450 VOLTS
15 AMPS, 125 WATTS

The MJH13090 and MJH13091 transistors are designed for high-voltage, high-speed power switching in inductive circuits where fall time is critical. They are particularly suited for line operated switch-mode applications such as:

Features:

- Switching regulators
- Inverters
- Solenoid and Relay drivers
- Motor Controls
- Deflection circuits

100°C Performance Specified for:
Reverse-Biased SOA with inductive loads
Switching times with inductive loads —
50 ns inductive fall time (Typ)
Saturation voltages
Leakage currents



maximum ratings ($T_A = 25^\circ\text{C}$) (unless otherwise noted)

RATING	SYMBOL	MJH13090	MJH13091	UNITS
Collector-Emitter Voltage	V_{CEO}	400	450	Volts
Collector-Emitter Voltage	V_{CEV}	650	750	Volts
Emitter Base Voltage	V_{EBO}	6	6	Volts
Collector Current — Continuous	I_C	15	15	A
Peak (Repetitive) ⁽¹⁾	I_{CM}	20	20	A
Base Current — Continuous	I_B	5	5	A
Peak (Non-Repetitive) ⁽¹⁾	I_{BM}	10	10	A
Total Power Dissipation @ $T_c = 25^\circ\text{C}$	P_D	125	125	Watts
Derate above 25°C		50	50	
		1	1	W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{STG}	-55 to +150	-55 to +150	$^\circ\text{C}$

thermal characteristics

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	1.0	$^\circ\text{C/W}$
Maximum Lead Temperature for Soldering Purpose: 1/8" from Case for 5 Seconds	T_L	275	275	$^\circ\text{C}$

(1) Pulse Test: Pulse Width = 5ms. Duty Cycle $\leq 10\%$.

electrical characteristics ($T_C = 25^\circ\text{C}$) (unless otherwise specified)

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNIT
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off characteristics⁽¹⁾

Collector-Emitter Sustaining Voltage ($I_C = 100\text{mA}$, $I_B = 0$)	MJH13090 MJH13091	$V_{CEO(sus)}$	400 450	— —	— —	Volts
Collector Cutoff Current ($V_{CEV} = \text{Rated Value}$, $V_{BE(OFF)} = 1.5\text{V}$) ($V_{CEV} = \text{Rated Value}$, $V_{BE(OFF)} = 1.5\text{V}$, $T_C = 100^\circ\text{C}$)		I_{CEV}	— —	— —	0.5 2.5	mA
Collector Cutoff Current ($V_{CE} = \text{Rate } V_{CEV}$, $R_{BE} = 50\Omega$, $T_C = 100^\circ\text{C}$)		I_{CER}	—	—	3	mA
Emitter Cutoff Current ($V_{EB} = 6\text{V}$, $I_C = 0$)		I_{EBO}	—	—	1	mA

second breakdown

Second Breakdown with Base Forward Biased	FBSOA	SEE FIGURE 12
Clamped Inductive SOA with Base Reversed Bias	RBSOA	SEE FIGURE 13

on characteristics

DC Current Gain ($I_C = 10\text{A}$, $V_{CE} = 3\text{V}$)	h_{FE}	8.0	—	—	—
Collector-Emitter Saturation Voltage ($I_C = 10\text{A}$, $I_B = 2\text{A}$) ($I_C = 15\text{A}$, $I_B = 3\text{A}$) ($I_C = 10\text{A}$, $I_B = 2\text{A}$, $T_C = 100^\circ\text{C}$)	$V_{CE(sat)}$	— — —	— — —	1 3 2	V
Base-Emitter Saturation Voltage ($I_C = 10\text{A}$, $I_B = 2\text{A}$) ($I_C = 10\text{A}$, $I_B = 2\text{A}$, $T_C = 100^\circ\text{C}$)	$V_{BE(sat)}$	— —	— —	1.5 1.5	V

switching characteristics

Resistive Load							
Delay Time	$V_{CC} = 250V, I_C = 10A$ $I_{B1} = I_{B2} = 1.25A,$ $t_p = 30 \mu sec$		t_d	—	0.03	0.05	μs
Rise Time			t_r	—	0.13	0.5	
Storage Time			t_s	—	0.55	2.5	
Fall Time			t_f	—	0.10	0.5	
Inductive Load, Clamped							
Storage Time	$I_{CC(PK)} = 10A$ $I_{B1} = 1.25A$ $V_{BE(OFF)} = 5V$ $V_{CE(PK)} = 250V$	$(T_J = 100^\circ C)$	t_{sv}	—	0.8	3	μs
Crossover Time			t_c	—	.175	.4	
Fall Time			t_{fi}	—	.15	.3	
Storage Time		$(T_J = 25^\circ C)$	t_{sv}	—	.50	—	
Crossover Time			t_c	—	.15	—	
Fall Time			t_{fi}	—	.10	—	

(1) Pulse Test: Pulse Width - $300\mu\text{s}$ Duty Cycle $\leq 2\%$

TYPICAL ELECTRICAL CHARACTERISTICS

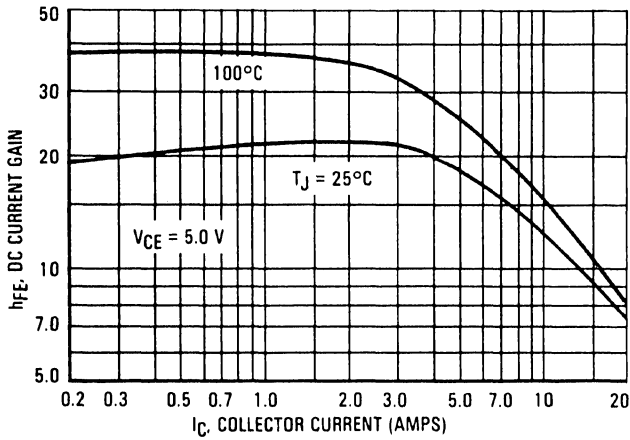


FIGURE 1 — DC CURRENT GAIN

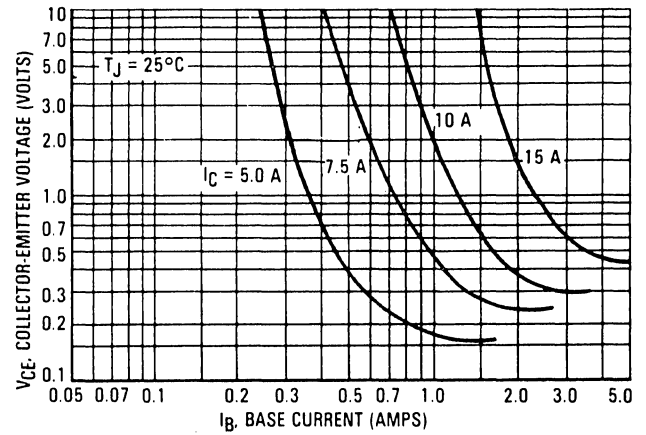


FIGURE 2 — COLLECTOR SATURATION REGION

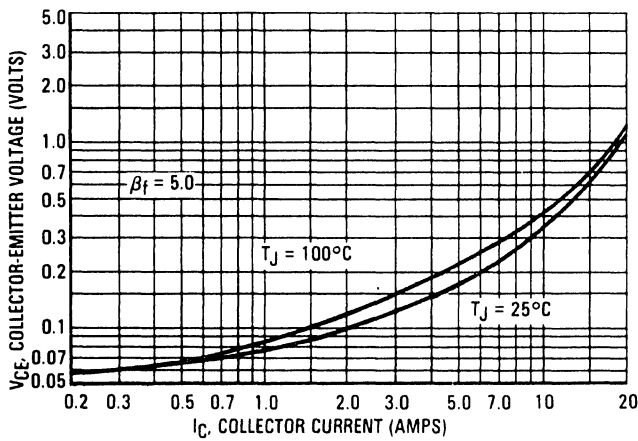


FIGURE 3 — COLLECTOR-EMITTER SATURATION VOLTAGE

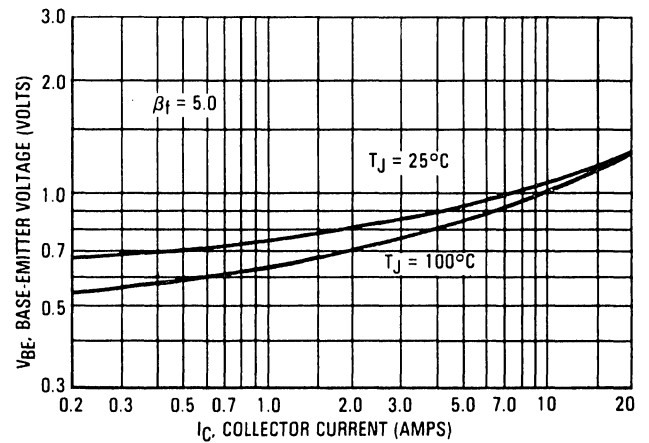


FIGURE 4 — BASE-EMITTER VOLTAGE

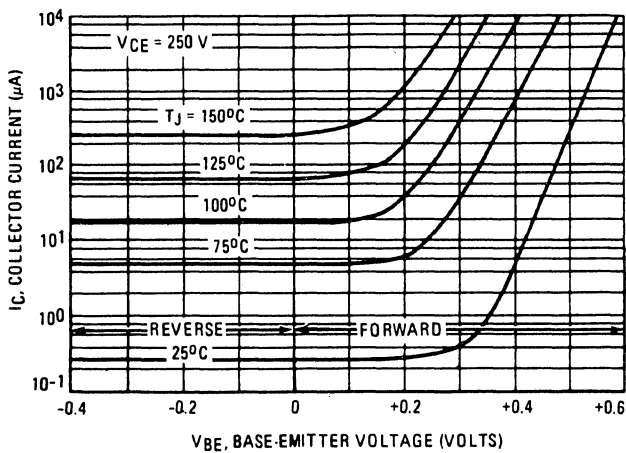


FIGURE 5 — COLLECTOR CUTOFF REGION

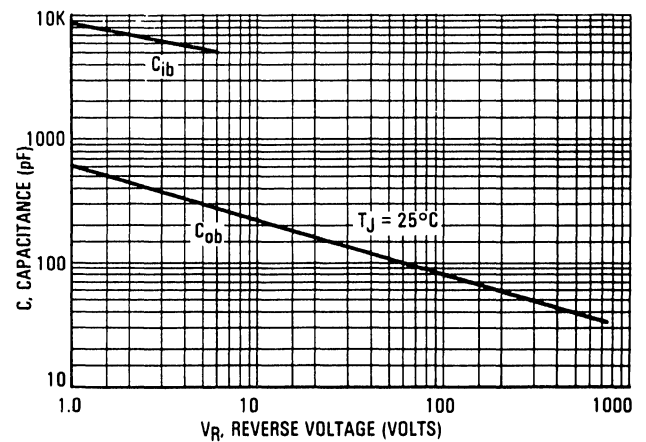


FIGURE 6 — CAPACITANCE

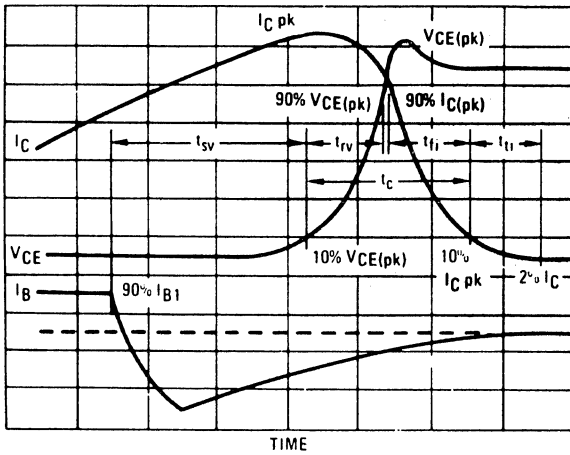


FIGURE 7 — INDUCTIVE SWITCHING MEASUREMENTS

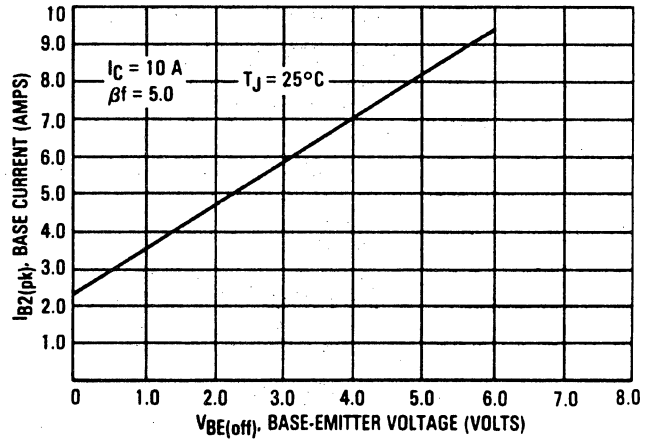


FIGURE 8 — PEAK REVERSE CURRENT

INDUCTIVE SWITCHING

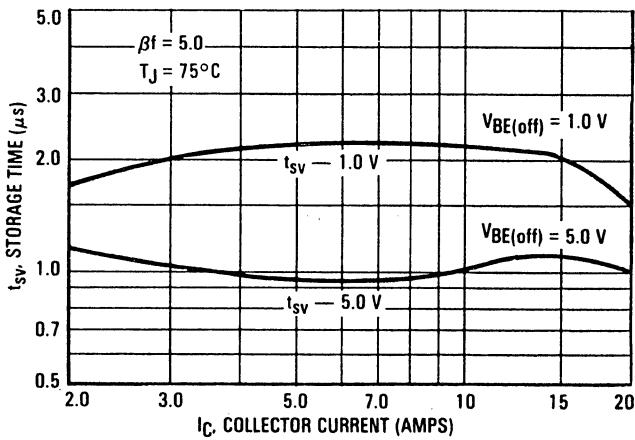


FIGURE 9 — STORAGE TIME

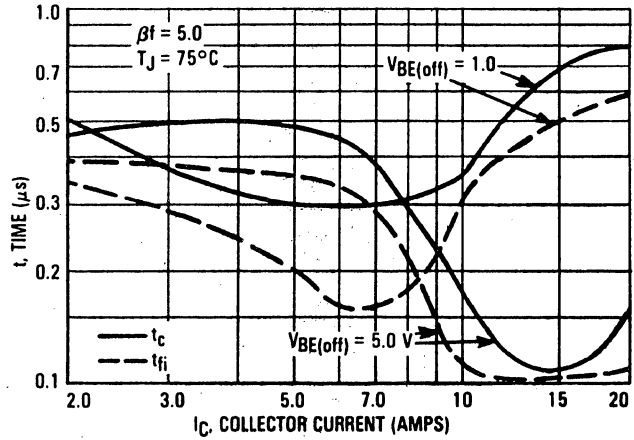


FIGURE 10 — CROSSOVER AND FALL TIMES

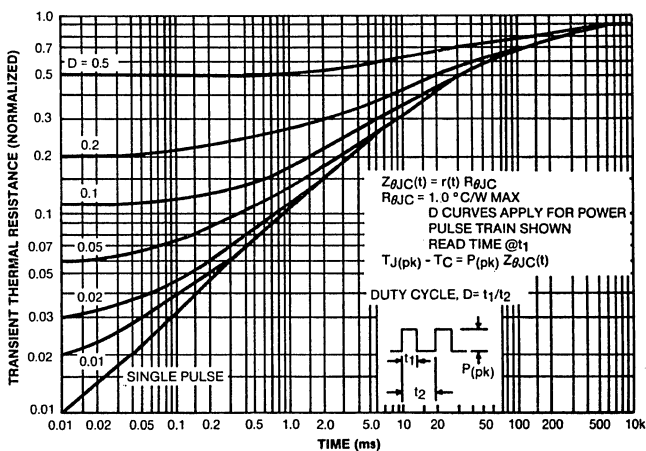


FIGURE 11 TYPICAL THERMAL RESPONSE $[(Z_{\theta JC}(t))]$

The Safe Operating Area figures shown in Figures 12 and 13 are specified for these devices under the test conditions shown.

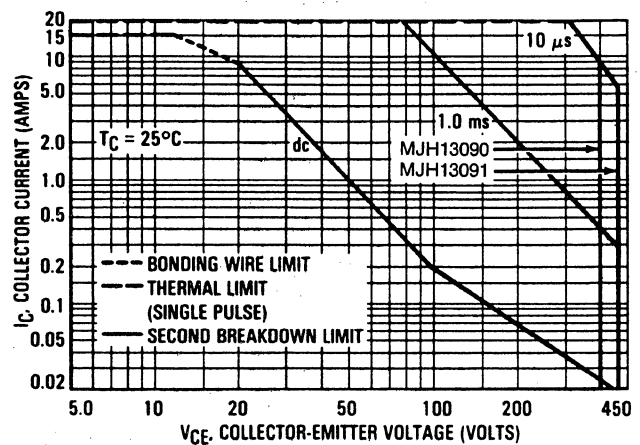


FIGURE 12 — FORWARD BIAS SAFE OPERATING AREA

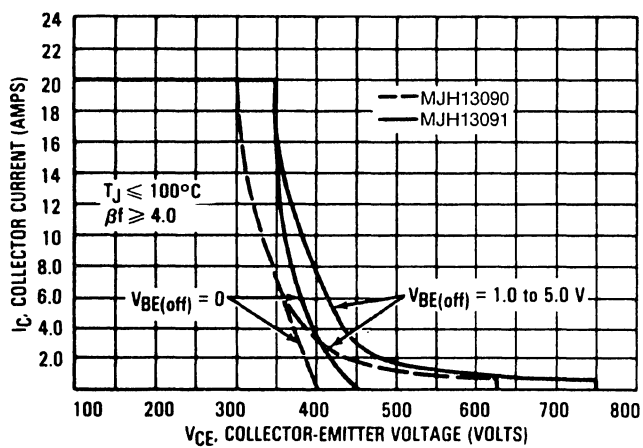


FIGURE 13 — REVERSE BIAS SAFE OPERATING AREA

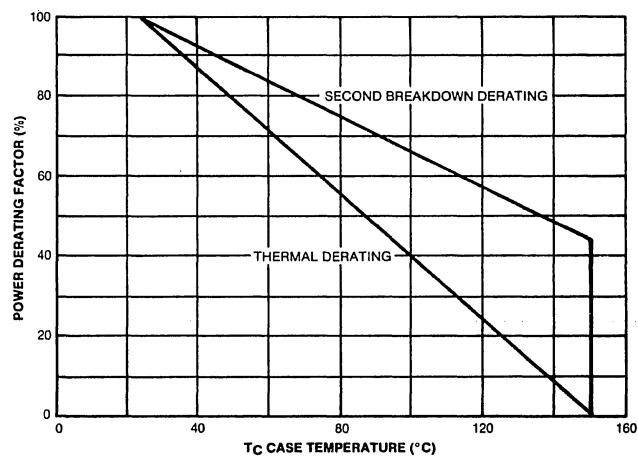


FIGURE 14 — POWER DERATING